MH302

PCS/UMTS-band Quad-FET Mixer

The Communications Edge ™

Product Information

Product Features

- +27 dBm Input IP3
- RF 1800 – 2000 MHz
- IF 200 – 300 MHz
- Low-side LO configuration
- +13 dBm LO Drive Level
- High L-I & L-R Isolation (>30 dB)
- Lead-free/green/RoHS-compliant 6-pin 3x3 mm DFN package
- No External Bias Required

Applications

- 2.5G/3G GSM/CDMA/WCDMA

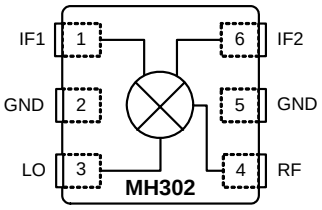
Product Description

The MH302 is a passive Quad-MOSFET mixer that provides high dynamic range performance in a low cost 3x3 mm 6-pin DFN (Dual Flat No-Lead) lead-free/green/RoHS-compliant package.

WJ's MH302 uses patented techniques to realize +27 dBm Input IP3 at an LO drive level of +13 dBm when used in a simple application circuit with a low-side LO configuration. The LO can also be driven with higher power levels up +20 dBm to achieve higher IP3 performance. This mixer integrates internal circuitry to provide single-ended interfaces for the RF & LO ports.

Typical applications include frequency up/down conversion, modulation and demodulation for receivers and transmitters used in 3G UMTS, PCS, and DCS1800 mobile infrastructure.

Functional Diagram



Function	Pin No.
IF Differential Input	1
LO port	3
RF port	4
IF differential Input	6
Ground	2, 5

Specifications

Parameters	Units	Minimum	Typical	Maximum	Comments
RF Frequency Range	MHz	1800		2000	
LO Frequency Range	MHz	1540		1740	
IF Frequency Range	MHz	200	260	300	See note 2
SSB Conversion Loss	dB		7.5	8.0	See note 3
Input IP3	dBm	+23	+25		RF = 1.8 GHz, See note 4
Input IP3	dBm	+26	+27		RF = 1.9 GHz, See note 4
Input IP3	dBm	+23	+25		RF = 2.0 GHz, See note 4
Input 1 dB Compression Point	dBm	+16	+18		See note 5
Noise Figure	dB		8		
LO Input Drive Level	dBm		+13		
LO-RF Isolation	dB	28	32		
LO-IF Isolation	dB	29	35		
Return Loss: RF Port	dB		15		
Return Loss: LO Port	dB		10		
Return Loss: IF Port	dB		15		

1. Data was taken using an application board in a 50 Ω system, with a low side LO at +13 dBm in a downconverting application at 25 °C with an IF frequency = 260 MHz.
2. An IF frequency of 260 MHz is a nominal frequency. The IF frequency can be specified by the user within the constraints of the specified minimum and maximum RF & LO frequency range.
3. The conversion loss includes the loss of an IF transformer (M/A COM ETK4-2T, nominal loss 0.7 dB at 260 MHz).
4. Input IP3 is measured using two tones with an input power of +3 dBm / tone separated by 1 MHz.
5. Although the input P1dB level is much higher, the continuous RF input power should not exceed +12 dBm. Operation above +12 dBm may cause permanent damage.

Absolute Maximum Ratings

Parameters	Rating
Operating Case Temperature	-40 to +85 °C
Storage Temperature	-40 to +125 °C
LO Input Power	+20 dBm
RF Input Power	+12 dBm

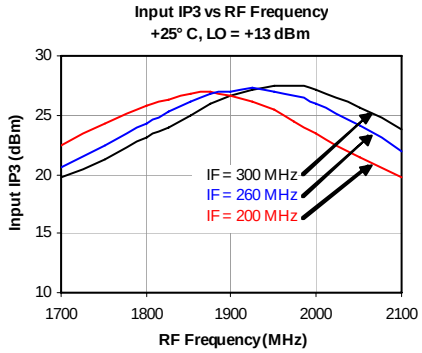
Operation of this device above any of these parameters may cause permanent damage.

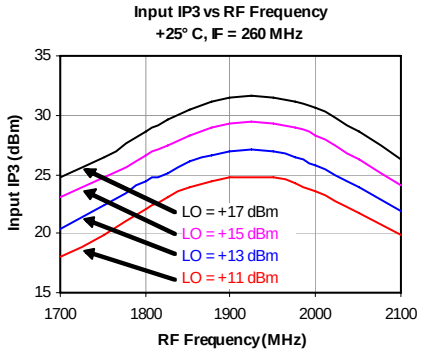
Ordering Information

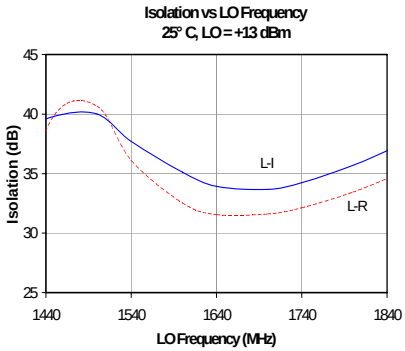
Part No.	Description
MH302-G	PCS/UMTS-band Quad-FET Mixer (lead-free/green/RoHS-compliant Package)
MH302-PCB	Fully-Assembled MH302 Application Board

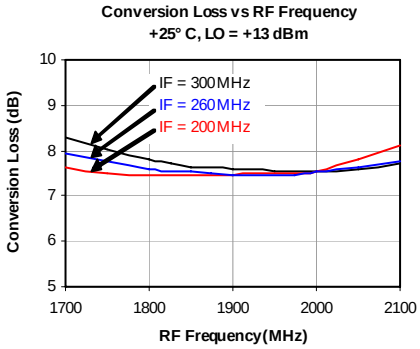
Specifications and information are subject to change without notice

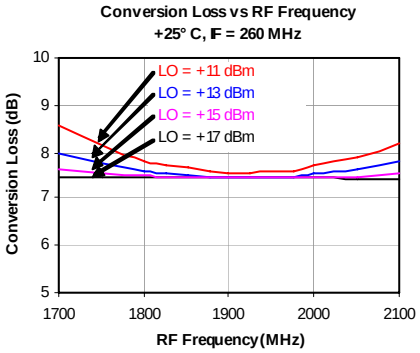
Typical Performance Charts

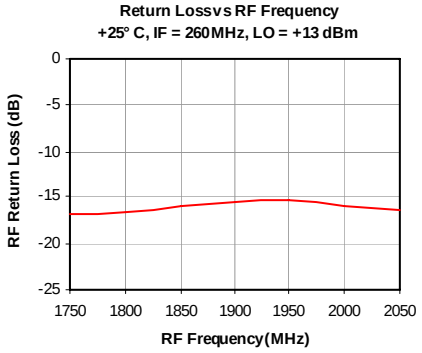


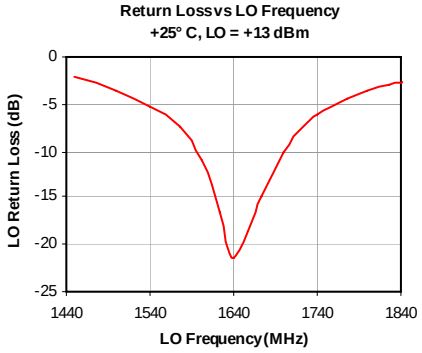


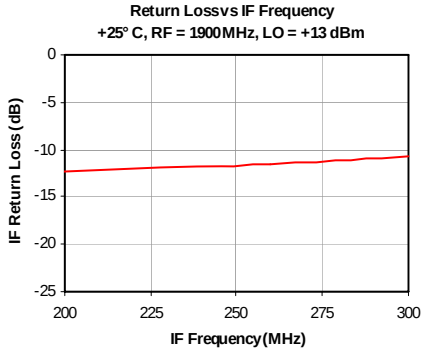




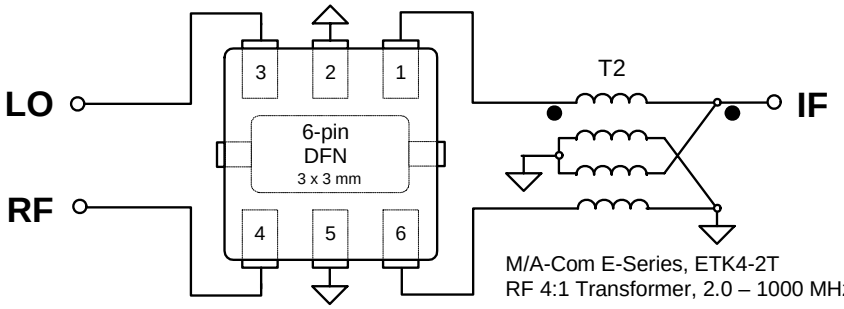








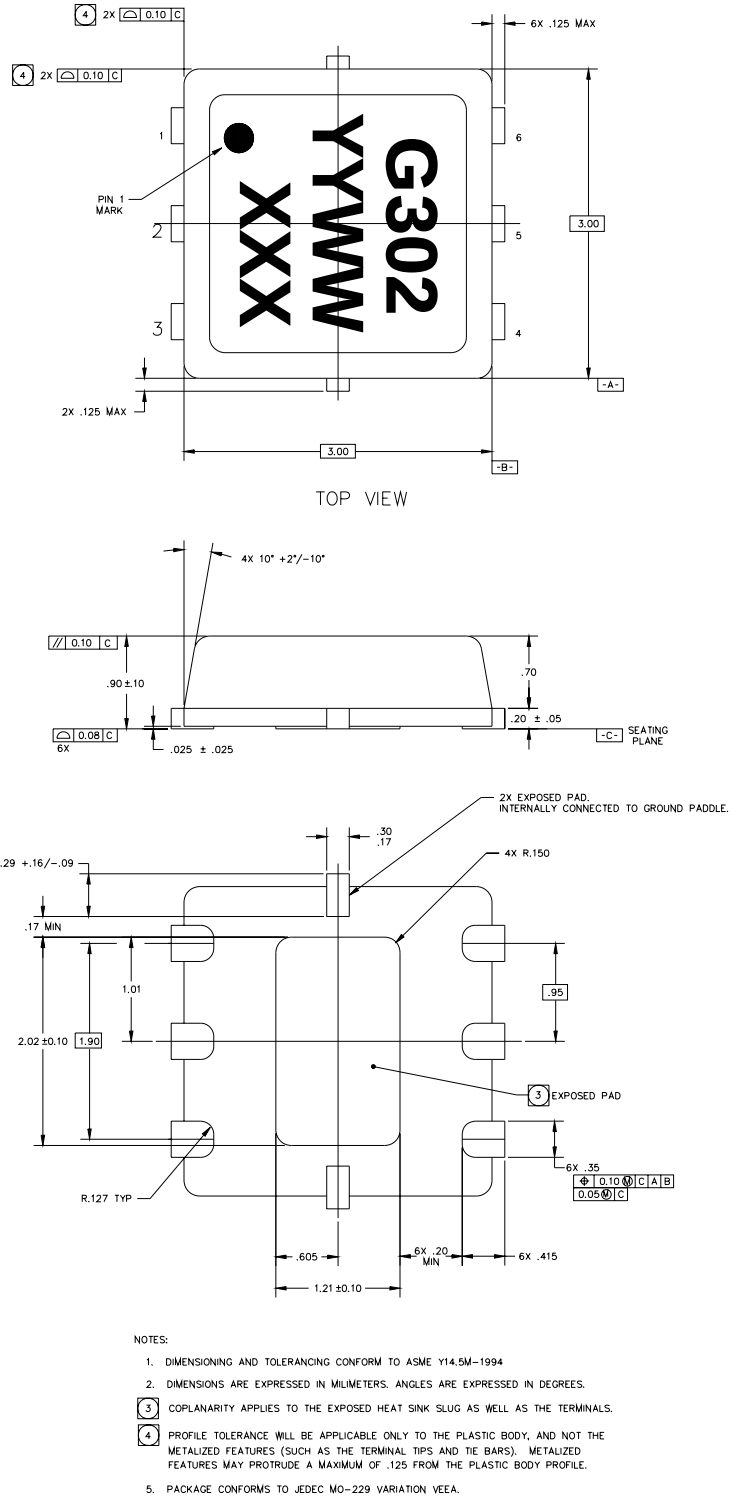
Application Circuit



MH302-G Mechanical Information

This package is lead-free/Green/RoHS-compliant. The plating material on the leads is annealed matte tin over copper. It is compatible with both lead-free (maximum 260 °C reflow temperature) and leaded (maximum 245 °C reflow temperature) soldering processes.

Package Information



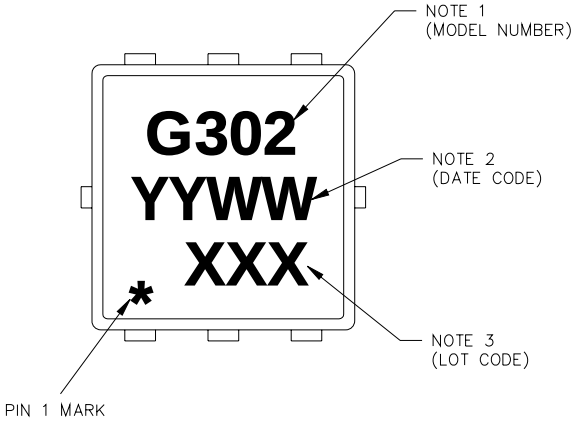
NOTES:

1. DIMENSIONING AND TOLERANCING CONFORM TO ASME Y14.5M–1994
2. DIMENSIONS ARE EXPRESSED IN MILIMETERS. ANGLES ARE EXPRESSED IN DEGREES.
3. COPLANARITY APPLIES TO THE EXPOSED HEAT SINK SLUG AS WELL AS THE TERMINALS.
4. PROFILE TOLERANCE WILL BE APPLICABLE ONLY TO THE PLASTIC BODY, AND NOT THE METALIZED FEATURES (SUCH AS THE TERMINAL TIPS AND TIE BARS). METALIZED FEATURES MAY PROTRUDE A MAXIMUM OF .125 FROM THE PLASTIC BODY PROFILE.
5. PACKAGE CONFORMS TO JEDEC MO-229 VARIATION VEEA.

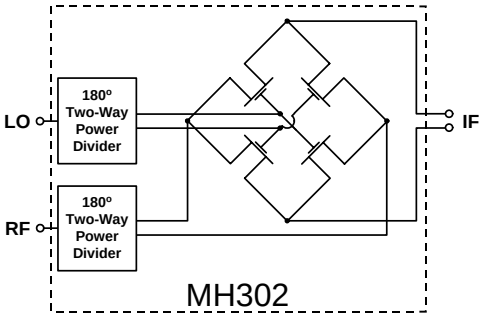
Product Marking

The component will be laser marked with a model number "G302" designator exactly as shown followed by an assembly date code in location shown by "YYWW". A laser marked lot code will be in the location shown by "XXX" and is unique for every assembly lot. The obsolete tin-lead package is marked with an "M302" designator.

Tape and reel specifications for this part are located on the website in the "Application Notes" section.



Functional Schematic Diagram



ESD / MSL Information

ESD Rating:	Class 1B
Value:	Passes at 500 V
Test:	Human Body Model (HBM)
Standard:	JEDEC Standard JESD22-A114
MSL Rating:	Level 1 at 260 °C convection reflow
Standard:	JEDEC Standard J-STD-020